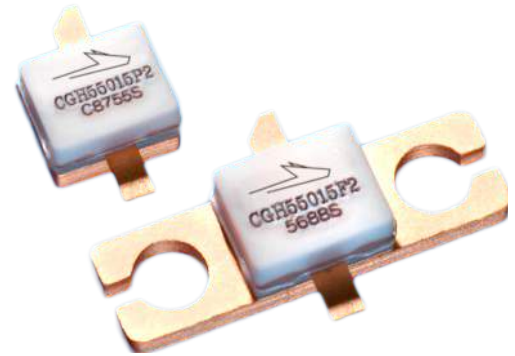


# CGH55015F2/P2

10 W, C-Band, Unmatched, GaN HEMT

## Description

WolfSpeed's CGH55015F2/P2 is a gallium nitride (GaN) high electron mobility transistor (HEMT) designed specifically for high efficiency, high gain and wide bandwidth capabilities, which makes the CGH55015F2/P2 ideal for C-band pulsed or CW saturated amplifiers. The transistor is available in both screwdown, flange and solder-down, pill packages. Based on appropriate external match adjustment, the CGH55015F2/P2 is suitable for applications up to 6 GHz.



Package Types: 440196 & 440166  
PNs: CGH55015P2 & CGH55015F2

## Features

- 4.5 to 6.0 GHz Operation
- 12 dB Small Signal Gain at 5.65 GHz
- 13 W typical  $P_{SAT}$
- 60% Efficiency at  $P_{SAT}$
- 28 V Operation

## Applications

- 2-Way Private Radio
- Broadband Amplifiers
- Cellular Infrastructure
- Test Instrumentation
- Class A, AB, Amplifiers suitable for OFDM, W-CDMA, EDGE, CDMA waveforms

 Large Signal Models Available for ADS and MWO





## Absolute Maximum Ratings (not simultaneous) at 25°C Case Temperature

Parameter	Symbol	Rating	Units	Conditions
Drain-Source Voltage	$V_{DSS}$	120	V	25°C
Gate-to-Source Voltage	$V_{GS}$	-10, +2		
Storage Temperature	$T_{STG}$	-65, +150	°C	
Operating Junction Temperature	$T_J$	225		
Maximum Forward Gate Current	$I_{GMAX}$	4.0	mA	25°C
Maximum Drain Current <sup>1</sup>	$I_{DMAX}$	1.5	A	
Soldering Temperature <sup>2</sup>	$T_S$	245	°C	
Screw Torque	$\tau$	40	in-oz	
Thermal Resistance, Junction to Case <sup>3</sup>	$R_{\theta JC}$	8.0	°C/W	85°C
Case Operating Temperature <sup>3,4</sup>	$T_C$	-40, +150	°C	30 seconds

Notes:

<sup>1</sup> Current limit for long term, reliable operation

<sup>2</sup> Refer to the Application Note on soldering at [wolfspeed.com/rf/document-library](http://wolfspeed.com/rf/document-library)

<sup>3</sup> Measured for the CGH55015 at  $P_{DISS} = 14$  W

<sup>4</sup> See also, the Power Dissipation De-rating Curve on Page 5

## Electrical Characteristics ( $T_C = 25^\circ\text{C}$ )

Characteristics	Symbol	Min.	Typ.	Max.	Units	Conditions
<b>DC Characteristics<sup>1</sup></b>						
Gate Threshold Voltage	$V_{GS(th)}$	-3.8	-3.0	-2.3	$V_{DC}$	$V_{DS} = 10$ V, $I_D = 3.6$ mA
Gate Quiescent Voltage	$V_{GS(Q)}$	—	-2.7	—		$V_{DS} = 28$ V, $I_D = 200$ A
Saturated Drain Current	$I_{DS}$	2.9	3.5	—	A	$V_{DS} = 6.0$ V, $V_{GS} = 2.0$ V
Drain-Source Breakdown Voltage	$V_{BR}$	84	—	—	$V_{DC}$	$V_{GS} = -8$ V, $I_D = 3.6$ mA
<b>RF Characteristics<sup>2</sup> (<math>T_C = 25^\circ\text{C}</math>, <math>F_0 = 5.65</math> GHz unless otherwise noted)</b>						
Small Signal Gain	$G_{SS}$	10	12	—	dB	$V_{DD} = 28$ V, $I_{DQ} = 200$ mA
Output Power <sup>3</sup>	$P_{SAT}$		12.5	—		
Drain Efficiency <sup>4</sup>	$\eta$	50	60	—	%	$V_{DD} = 28$ V, $I_{DQ} = 200$ mA, $P_{OUT} = 10$ W
Output Mismatch Stress	VSWR	—	—	10 : 1	$\Psi$	No damage at all phase angles, $V_{DD} = 28$ V, $I_{DQ} = 200$ mA, $P_{OUT} = 10$ W CW
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{GS}$	—	4.5	—	pF	$V_{DS} = 28$ V, $V_{GS} = -8$ V, $f = 1$ MHz
Output Capacitance	$C_{DS}$	—	1.3	—		
Feedback Capacitance	$C_{GD}$	—	0.2	—		

Notes:

<sup>1</sup> Measured on wafer prior to packaging

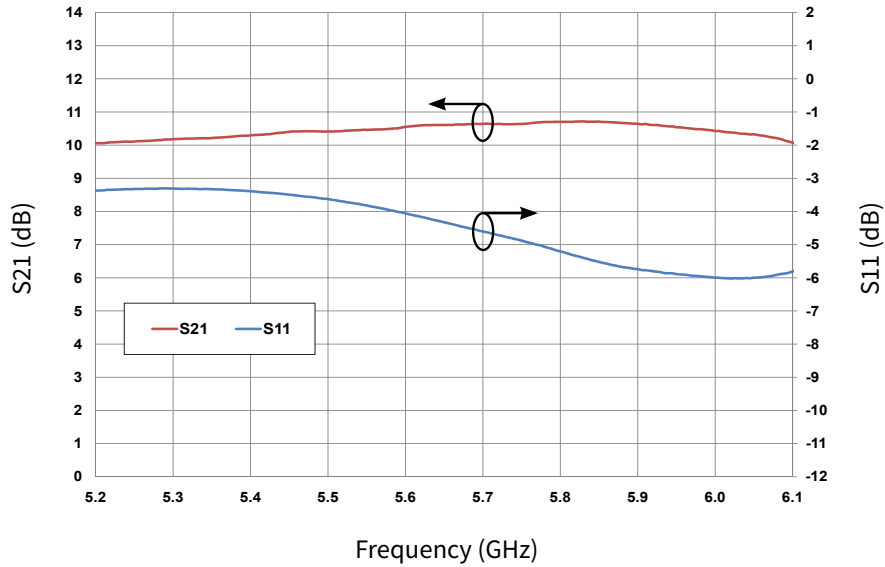
<sup>2</sup> Measured in the CGH55015-AMP

<sup>3</sup>  $P_{SAT}$  is defined as  $I_G = 0.36$  mA

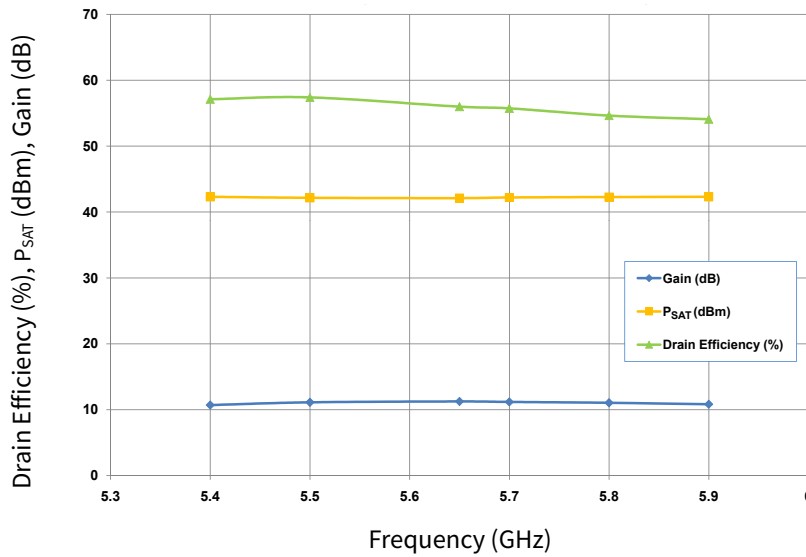
<sup>4</sup> Drain Efficiency =  $P_{OUT}/P_{DC}$



Typical Performance



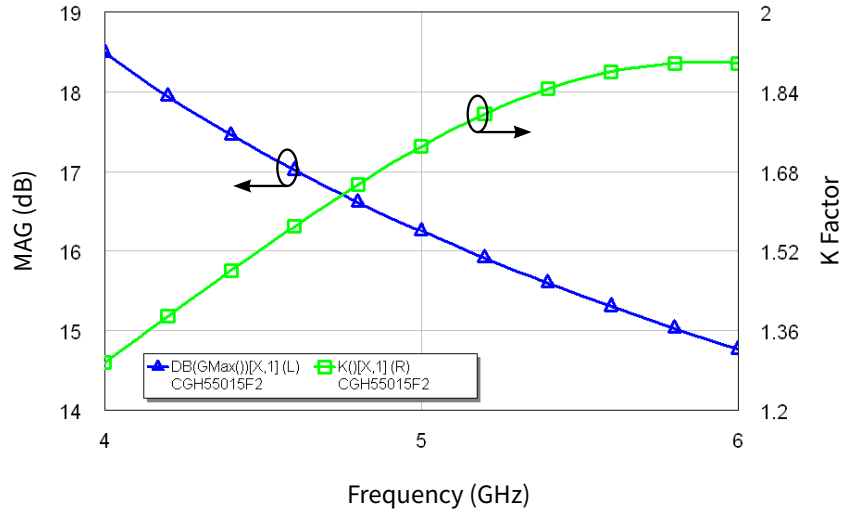
**Figure 1.** Small Signal S-Parameters vs Frequency of CGH55015F2 and CGH55015P2 in the CGH55015-AMP  
 $V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 200\text{ mA}$



**Figure 2.** Drain Efficiency, Power and Gain vs Frequency of the CGH55015F2 and CGH55015P2 in the CGH55015-AMP  
 $V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 200\text{ mA}$

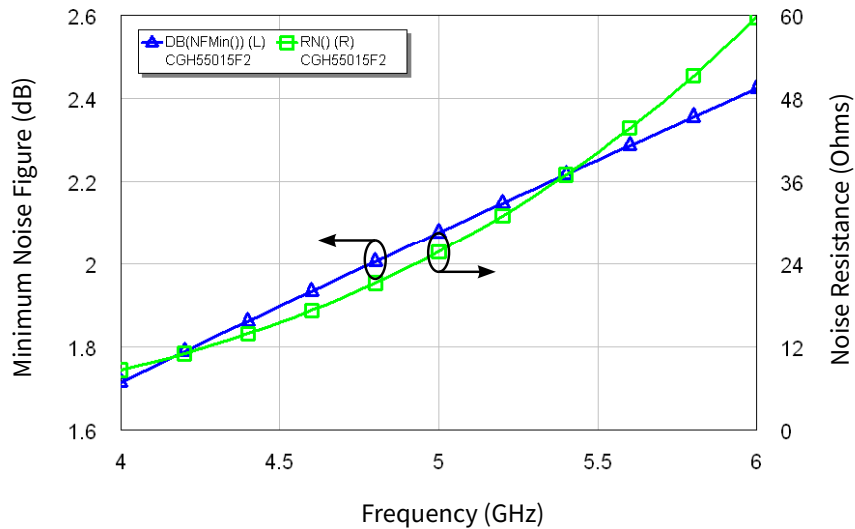


### Typical Performance



**Figure 3.** Simulated Maximum Available Gain and K Factor of the CGH55015F2 and CGH55015P2  
 $V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 200\text{ mA}$

### Typical Noise Performance



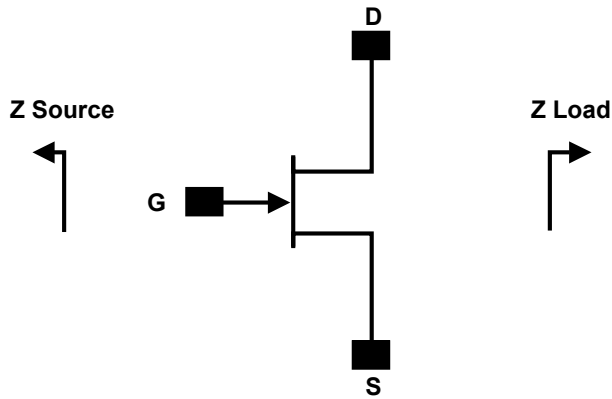
**Figure 4.** Simulated Minimum Noise Figure and Noise Resistance vs Frequency of the CGH55015F2 and CGH55015P2  
 $V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 200\text{ mA}$

### Electrostatic Discharge (ESD) Classifications

Parameter	Symbol	Class	Classification Level	Test Methodology
Human Body Model	HBM	0 (< 200V)	ANSI/ESDA/JEDEC JS-001 Table 3	JEDEC JESD22 A114-D
Charge Device Model	CDM	C3	ANSI/ESDA/JEDEC JS-002 Table 3	JEDEC JESD22 C101-C



### Source and Load Impedances

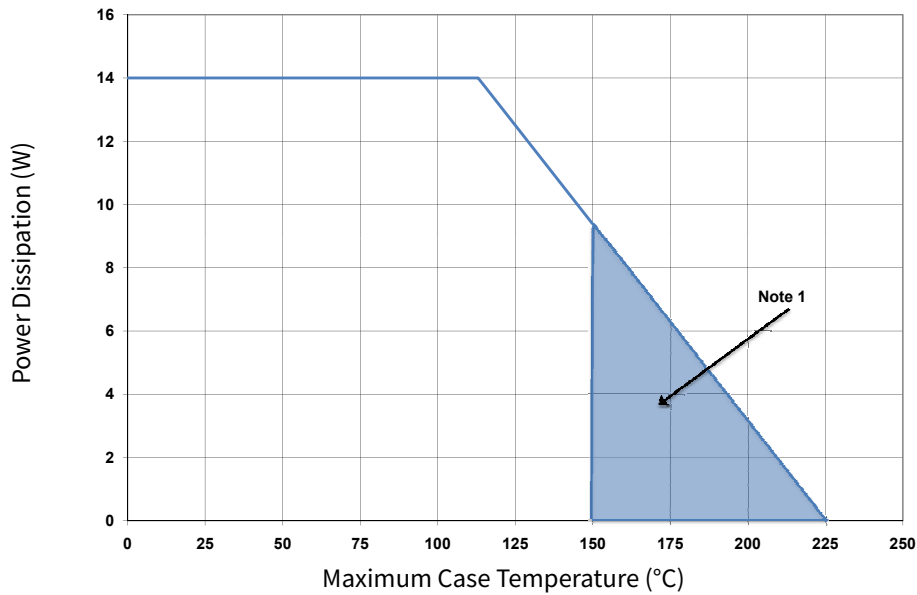


Frequency (MHz)	Z Source	Z Load
5500	8.7 - j30.2	21.6 - j4.7
5650	10.2 - j26.9	24.2 - j5.5
5800	12.3 - j24.3	26.5 - j7.5

Notes:

- <sup>1</sup>  $V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 250\text{ mA}$  in the 440166 package
- <sup>2</sup> Impedances are extracted from the CGH55015-AMP demonstration amplifier and are not source and load pull data derived from the transistor

### CGH55015F2 and CGH55015P2 Transient Power Dissipation De-rating Curve



Note:

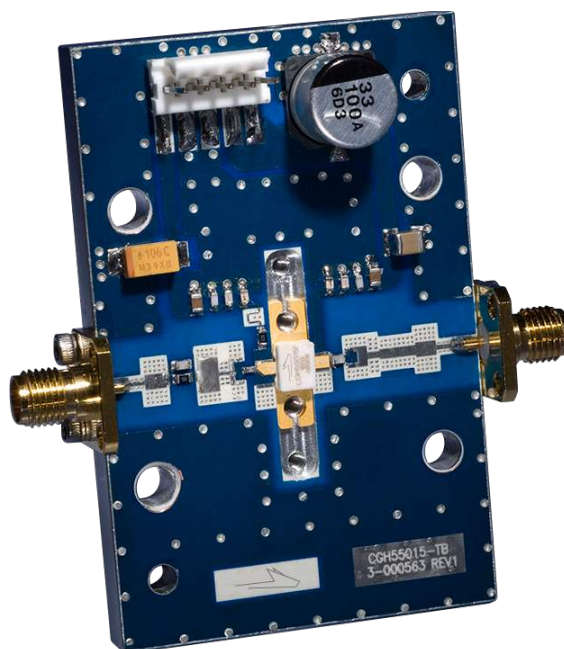
- <sup>1</sup> Area exceeds Maximum Case Operating Temperature (See Page 2)



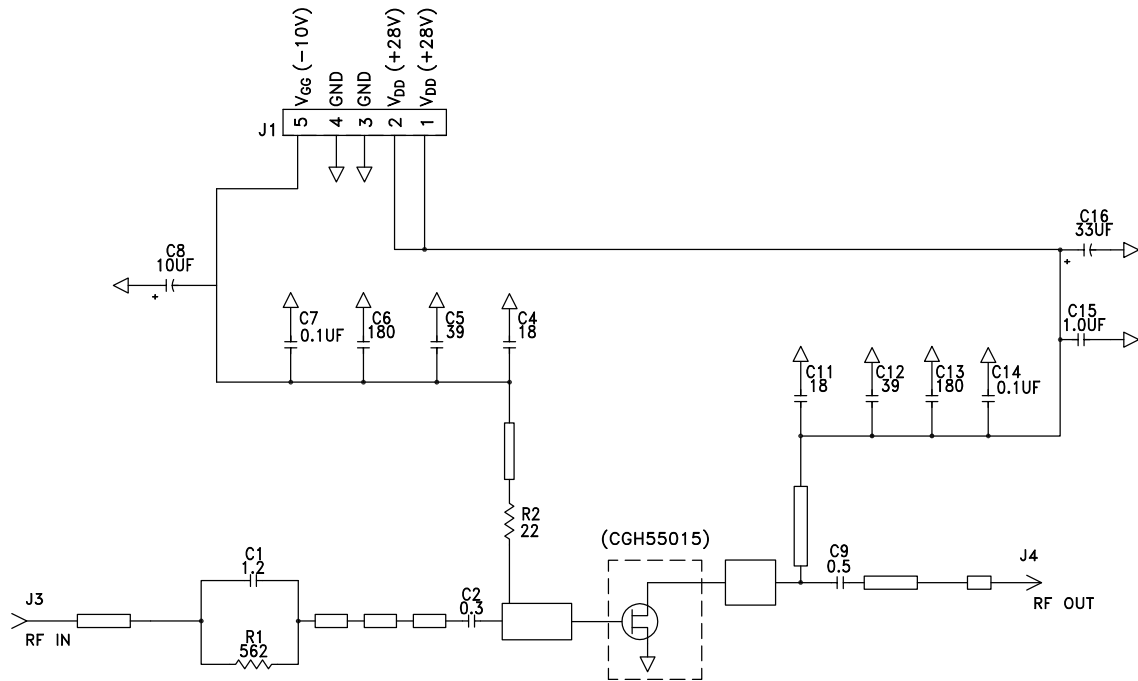
## CGH55015-AMP Demonstration Amplifier Circuit Bill of Materials

Designator	Description	Qty
C1	CAP, 1.2pF, +/-0.1pF, 0603, ATC 600S	1
C2	CAP, 0.3pF, +/-0.05pF, 0402, ATC 600L	1
C9	CAP, 0.5pF, +/-0.05pF, 0603, ATC 600S	1
C4, C11	CAP, 18pF, +/-5%, 0603, ATC 600S	2
C5, C12	CAP, 39pF +/-5%, 0603, ATC 600S	2
C6, C13	CAP, CER, 180pF, 50V, +/-5%, C0G, 0603	2
C7, C14	CAP, CER, 0.1μF, 50V, +/-10%, X7R, 0805	2
C8	CAP, 10μF, 16V, SMT, TANTALUM	1
C15	CAP, 1.0μF, ±10%, 100V, 1210, X7R	1
C16	CAP, 33μF, 100V, ELECT, FK, SMD	1
R1	RES, 1/16W, 0603, 1%, 562 OHMS	1
R2	RES, 1/16W, 0603, 1%, 22 OHMS	1
J1	HEADER RT> PLZ .1 CEN LK 5 POS	1
J3, J4	CONN, SMA, FLANGE	2
—	PCB, RO4350B, Er = 3.48, h = 20 mil	1
—	CGH55015	1

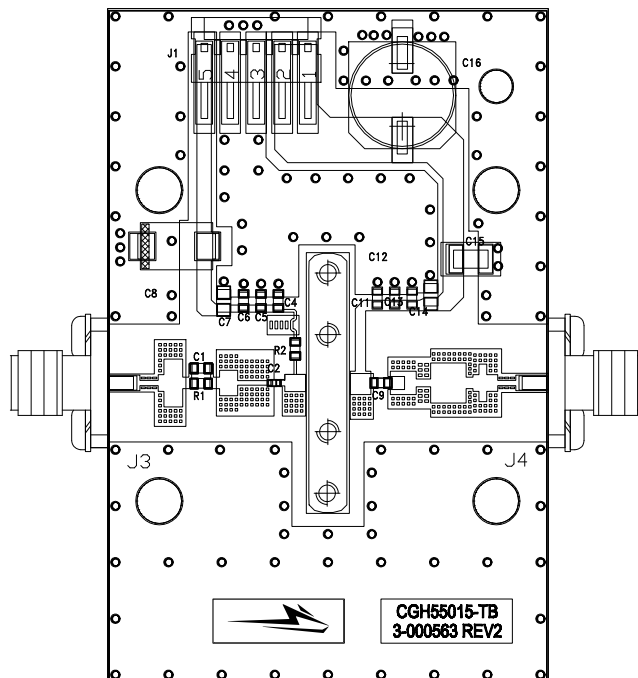
## CGH55015-AMP Demonstration Amplifier Circuit



### CGH55015-AMP Demonstration Amplifier Circuit Schematic



### CGH55015-AMP Demonstration Amplifier Circuit Outline





**Typical Package S-Parameters for CGH55015F2/P2**  
**(Small Signal,  $V_{DS} = 28\text{ V}$ ,  $I_{DQ} = 200\text{ A}$ , angle in degrees)**

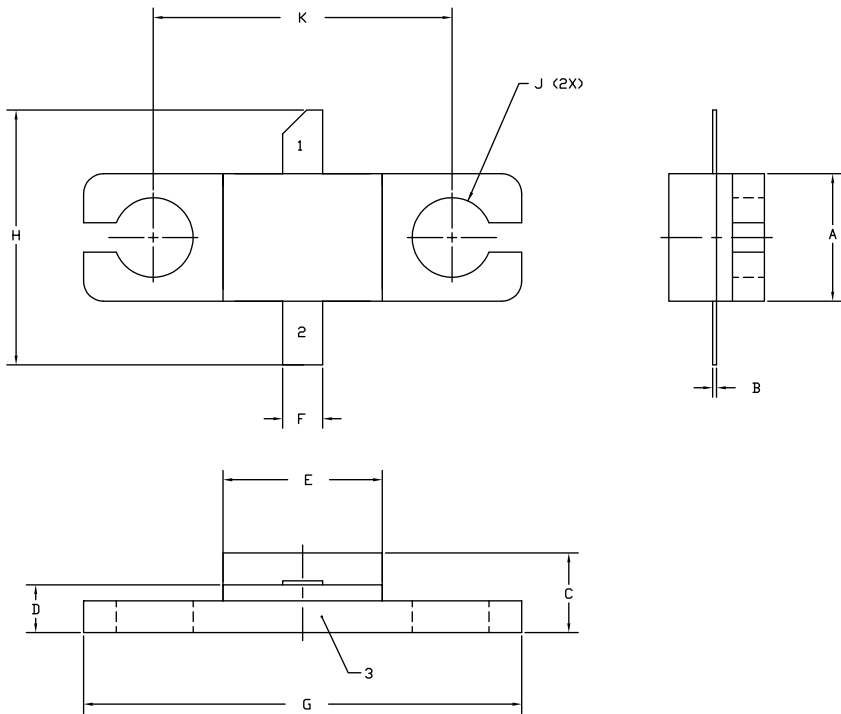
Frequency	Mag S11	Ang S11	Mag S21	Ang S21	Mag S12	Ang S12	Mag S22	Ang S22
500 MHz	0.911	-130.86	18.44	105.32	0.022	19.38	0.302	-113.00
600 MHz	0.906	-139.86	15.82	99.40	0.023	14.28	0.299	-120.56
700 MHz	0.902	-146.89	13.81	94.44	0.023	10.15	0.298	-126.20
800 MHz	0.900	-152.58	12.23	90.14	0.023	6.68	0.299	-130.51
900 MHz	0.898	-157.33	10.97	86.29	0.023	3.69	0.302	-133.91
1.0 GHz	0.897	-161.38	9.93	82.79	0.023	1.03	0.305	-136.65
1.1 GHz	0.896	-164.92	9.06	79.53	0.023	-1.36	0.309	-138.93
1.2 GHz	0.895	-168.07	8.33	76.47	0.023	-3.55	0.314	-140.86
1.3 GHz	0.895	-170.92	7.71	73.56	0.023	-5.58	0.320	-142.55
1.4 GHz	0.895	-173.52	7.17	70.77	0.023	-7.47	0.326	-144.06
1.5 GHz	0.894	-175.93	6.70	68.08	0.023	-9.25	0.332	-145.44
1.6 GHz	0.894	-178.19	6.29	65.47	0.023	-10.93	0.338	-146.73
1.7 GHz	0.894	179.68	5.92	62.93	0.023	-12.52	0.345	-147.96
1.8 GHz	0.894	177.66	5.60	60.44	0.023	-14.04	0.351	-149.13
1.9 GHz	0.894	175.72	5.31	58.01	0.022	-15.49	0.358	-150.28
2.0 GHz	0.894	173.85	5.04	55.62	0.022	-16.88	0.365	-151.42
2.1 GHz	0.895	172.04	4.80	53.26	0.022	-18.21	0.372	-152.54
2.2 GHz	0.895	170.28	4.59	50.93	0.022	-19.48	0.379	-153.66
2.3 GHz	0.895	168.57	4.39	48.64	0.022	-20.69	0.386	-154.78
2.4 GHz	0.895	166.88	4.21	46.37	0.021	-21.85	0.393	-155.92
2.5 GHz	0.895	165.22	4.04	44.11	0.021	-22.96	0.400	-157.06
2.6 GHz	0.895	163.58	3.88	41.88	0.021	-24.02	0.407	-158.21
2.7 GHz	0.895	161.97	3.74	39.67	0.021	-25.02	0.413	-159.37
2.8 GHz	0.896	160.36	3.61	37.47	0.020	-25.97	0.420	-160.55
2.9 GHz	0.896	158.76	3.49	35.28	0.020	-26.87	0.426	-161.75
3.0 GHz	0.896	157.17	3.37	33.11	0.020	-27.72	0.433	-162.96
3.2 GHz	0.896	153.99	3.17	28.79	0.019	-29.24	0.445	-165.43
3.4 GHz	0.896	150.81	2.99	24.49	0.019	-30.53	0.456	-167.97
3.6 GHz	0.897	147.59	2.83	20.21	0.018	-31.57	0.467	-170.58
3.8 GHz	0.897	144.34	2.69	15.94	0.018	-32.35	0.477	-173.26
4.0 GHz	0.897	141.03	2.56	11.67	0.017	-32.86	0.487	-176.01
4.2 GHz	0.897	137.66	2.45	7.39	0.017	-33.08	0.496	-178.84
4.4 GHz	0.897	134.20	2.35	3.09	0.017	-33.02	0.504	178.25
4.6 GHz	0.897	130.65	2.26	-1.24	0.016	-32.67	0.511	175.25
4.8 GHz	0.897	127.01	2.18	-5.61	0.016	-32.06	0.517	172.16
5.0 GHz	0.896	123.25	2.11	-10.03	0.016	-31.23	0.523	168.97
5.2 GHz	0.896	119.37	2.04	-14.50	0.016	-30.22	0.528	165.68
5.4 GHz	0.896	115.36	1.98	-19.04	0.016	-29.11	0.532	162.26
5.6 GHz	0.896	111.21	1.92	-23.65	0.016	-27.99	0.536	158.72
5.8 GHz	0.895	106.92	1.87	-28.34	0.017	-26.98	0.539	155.04
6.0 GHz	0.895	102.47	1.83	-33.12	0.017	-26.15	0.541	151.21

To download the s-parameters in s2p format, go to the [CGH55015F2/P2 Product page](#) and click on the documentation tab.





**Product Dimensions CGH55015F2 (Package Type — 440166)**



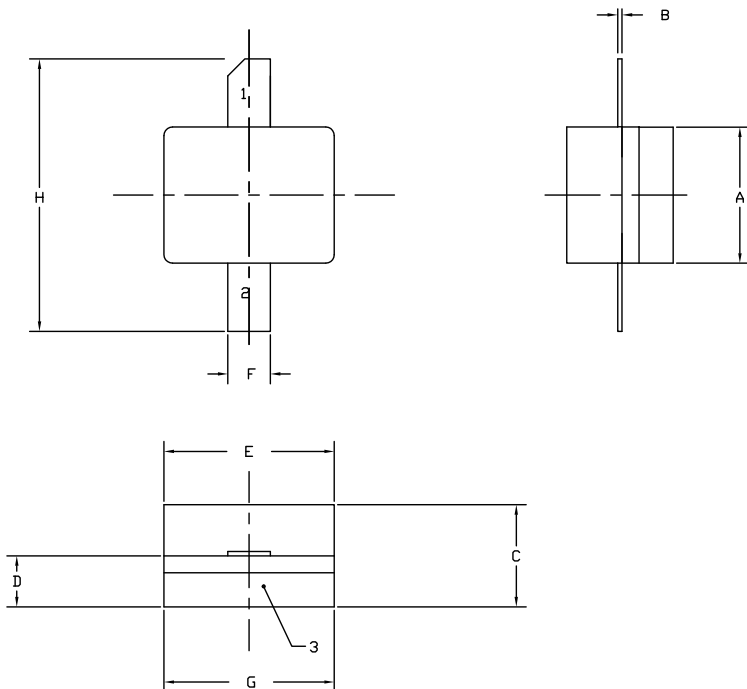
NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF 0.020" BEYOND EDGE OF LID.
4. LID MAY BE MISALIGNED TO THE BODY OF THE PACKAGE BY A MAXIMUM OF 0.008" IN ANY DIRECTION.
5. ALL PLATED SURFACES ARE NI/AU

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.155	0.165	3.94	4.19
B	0.004	0.006	0.10	0.15
C	0.115	0.135	2.92	3.43
D	0.057	0.067	1.45	1.70
E	0.195	0.205	4.95	5.21
F	0.045	0.055	1.14	1.40
G	0.545	0.555	13.84	14.09
H	0.280	0.360	7.11	9.14
J	Ø .100		2.54	
K	0.375		9.53	

- PIN 1. GATE  
 PIN 2. DRAIN  
 PIN 3. SOURCE

**Product Dimensions CGH55015P2 (Package Type — 440196)**



NOTES:

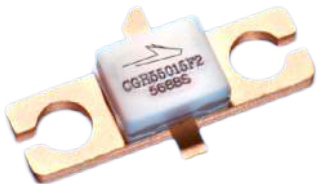


1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF 0.020" BEYOND EDGE OF LID.
4. LID MAY BE MISALIGNED TO THE BODY OF THE PACKAGE BY A MAXIMUM OF 0.008" IN ANY DIRECTION.
5. ALL PLATED SURFACES ARE NI/AU

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.155	0.165	3.94	4.19
B	0.003	0.006	0.10	0.15
C	0.115	0.135	2.92	3.17
D	0.057	0.067	1.45	1.70
E	0.195	0.205	4.95	5.21
F	0.045	0.055	1.14	1.40
G	0.195	0.205	4.95	5.21
H	0.280	0.360	7.11	9.14

- PIN 1. GATE  
 PIN 2. DRAIN  
 PIN 3. SOURCE



**Product Ordering Information**

Order Number	Description	Unit of Measure	Image
CGH55015F2	GaN HEMT	Each	
CGH55015P2	GaN HEMT	Each	
CGH55015F2-AMP1	Test board with GaN HEMT installed	Each	

**For more information, please contact:**

4600 Silicon Drive  
Durham, NC 27703 USA  
Tel: +1.919.313.5300  
[www.wolfspeed.com/RF](http://www.wolfspeed.com/RF)

Sales Contact  
[RFSales@wolfspeed.com](mailto:RFSales@wolfspeed.com)

RF Product Marketing Contact  
[RFMarketing@wolfspeed.com](mailto:RFMarketing@wolfspeed.com)

## Notes & Disclaimer

---

Specifications are subject to change without notice. “Typical” parameters are the average values expected by Wolfspeed in large quantities and are provided for information purposes only. Wolfspeed products are not warranted or authorized for use as critical components in medical, life-saving, or life-sustaining applications, or other applications where a failure would reasonably be expected to cause severe personal injury or death. No responsibility is assumed by Wolfspeed for any infringement of patents or other rights of third parties which may result from use of the information contained herein. No license is granted by implication or otherwise under any patent or patent rights of Wolfspeed.

© 2008-2022 Wolfspeed, Inc. All rights reserved. Wolfspeed® and the Wolfstreak logo are registered trademarks and the Wolfspeed logo is a trademark of Wolfspeed, Inc.  
PATENT: <https://www.wolfspeed.com/legal/patents>

*The information in this document is subject to change without notice.*